Surface Mount Chip Terminations

Style CZ

General Specifications

- Nominal Impedence: 50 Ω
- Resistive Tolerance: ±2% standard
- Operating Temp Range: -55 to +150°C
- Temperature Coefficient: ±150 ppm/°C
- Resistive Elements: Tantalum, Thin Film Processed
- Substrate Material: Aluminum Nitride
- Terminals: Silver over Nickel
- Lead-Free, RoHS Compliant
- Reliability: MIL-PRF-55342
- Tape and Reel Specifications: See Page 37

ATC Part Number Code

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<th>Case Style</th>
<th>Case Size</th>
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Indent in overcoat denotes back side RF Pad Location

Power Derating

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